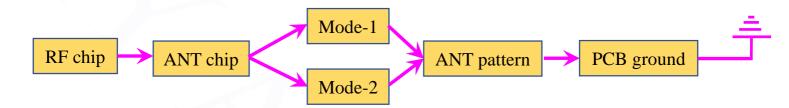
P/N: HY160808 SRF09

 Shenzhen Baoan District Qianjin 2 Road BaoYunda logistics information building 12A10 tel: 0755-23069700

Features:

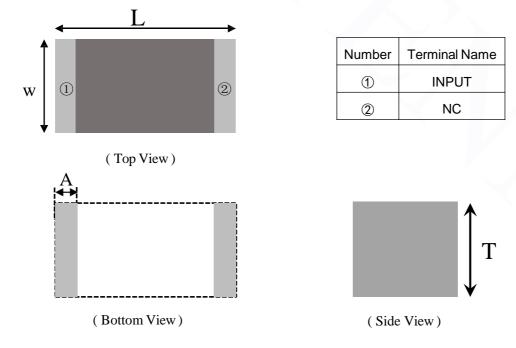
- 1. Surface mounted element with a small dimension of $1.6 \times 0.8 \times 0.8$ mm meet future miniaturization trend.
- 2. Embedded and LTCC (low temperature co-fired ceramic) technology is able to integrate with system design as well as beatifying the housing of final product.
- 3. Miniaturization, wideband, high stability, low ESR, and low tolerance.
- 4. Dual-band resonances in the dominant and harmonic modes enables multiband operations.
- 5. Novel ground-radiation technique enables radiation from both the antenna and the ground plane.



✓ Applications:

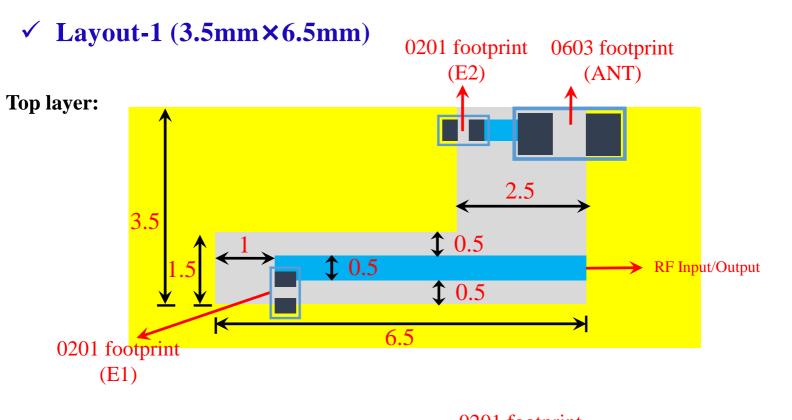
- 1. Bluetooth
- 2. Dual-band WLAN
- 3. ISM and UWB

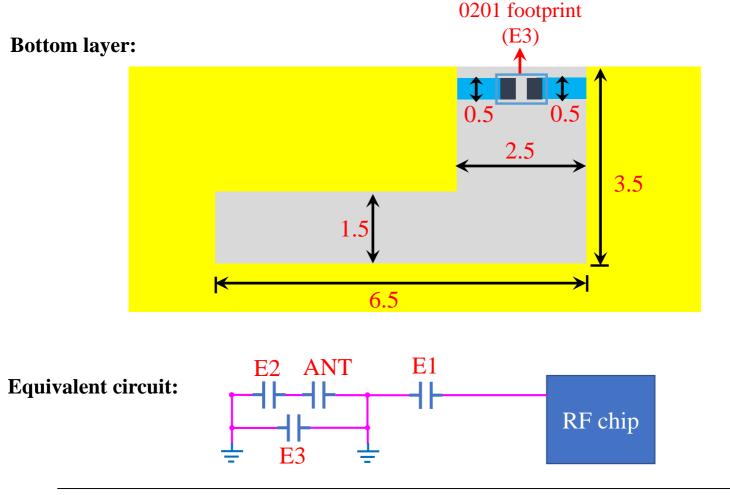
✓ Dimensions (Unit: mm)

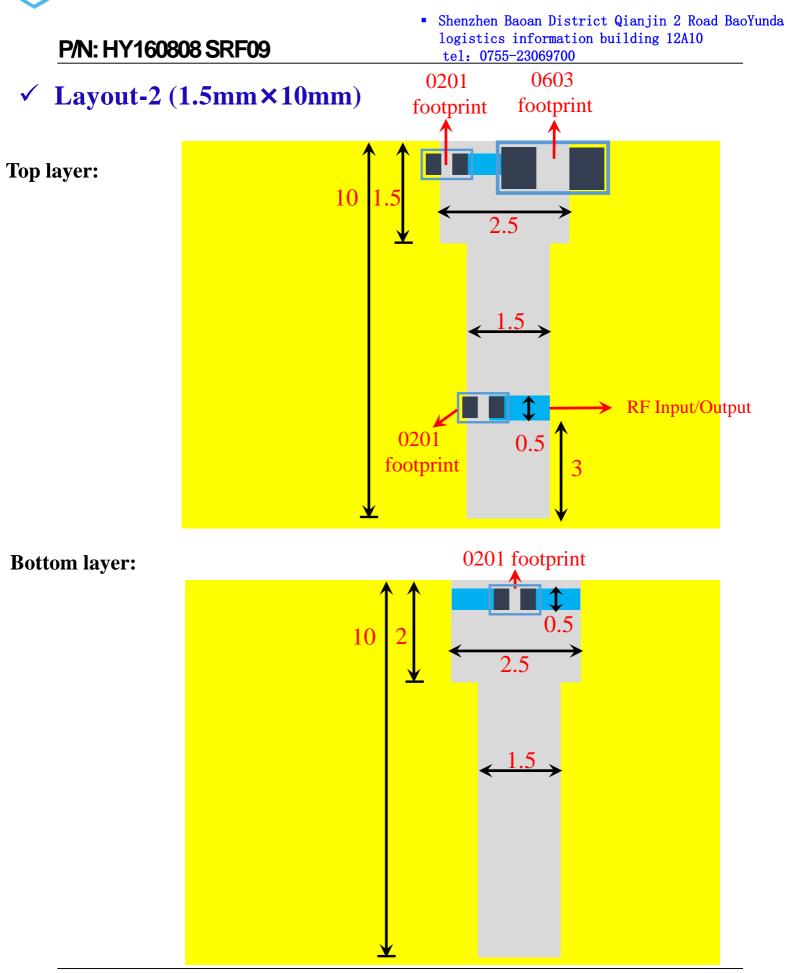


Symbols	ymbols L		Т	А	
Dimensions	1.60 ± 0.20	0.80 ± 0.20	0.80 ± 0.20	0.30 ± 0.10	

	Shenzhen Baoan District Qianjin 2 Road BaoYunda
P/N: HY160808 SRF09	logistics information building 12A10
	tel: 0755-23069700







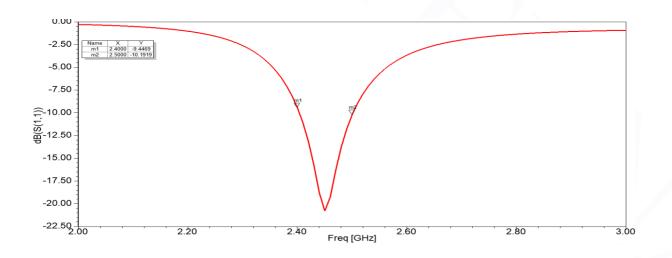
	Shenzhen Baoan District Qianjin 2 Road BaoYunda
	logistics information building 12A10
P/N: HY160808 SRF09	tel: 0755-23069700

✓ Electrical Characteristics:

	Feature	Specification		
1	Central frequency	2.45GHz		
2	Bandwidth	>150MHz		
3	Peak gain	2.78 dBi		
4	VSWR	<2		
5	Polarization	Linear		
6	Azimuth beamwidth	Omnidirectional		
7	Impedance	50 Ω		

Antenna type: SMD ANT

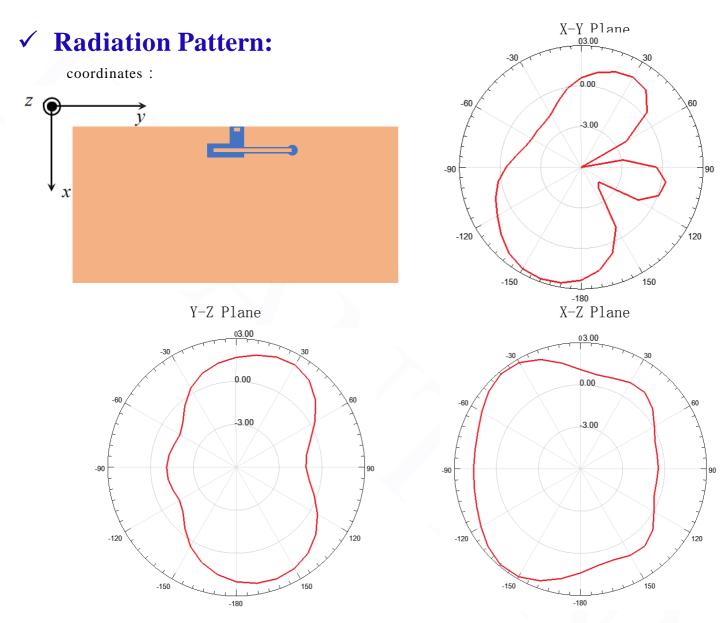
✓ Characteristic Curves:



深圳汉阳天线设计有限公司 Shenzhen Hanyang Antenna Design Co. Ltd.

- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
- 青岛市崂山区松岭路399号海信产业园A1号楼606
 - 电话: 0755-23069700 传真: 0755-23069700

P/N: HY160808 SRF07, HY160808 SRF08, HY160808 SRF09



✓ Radiation Performance:

Frequency	2400MHz	2450MHz	2500MHz
Avg. gain	-1.92	-1.35	-1.56
Peak gain	1.79	2.78	2.66
Efficiency	74.55	80.25	76.98

P/N: HY160808 SRF09

✓ Dependability Test

Test Temperature $25^{\circ}C \pm 5^{\circ}C$ Operating Temperature $-25^{\circ}C \sim +125^{\circ}C$ Temperature $5\sim 40^{\circ}C$ Relative Humidity $20\sim 70\%$

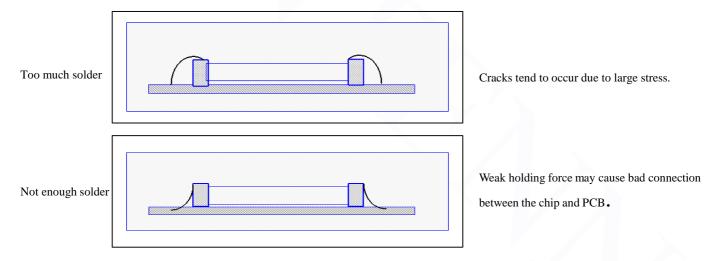
✓ Moisture Proof

Temperature: 40±2°C Humidity: 90~95%RH Duration: 500h Recovery conditions: Room temperature Recovery Time: 24h (Class1) or 48h (Class2)

Solderability

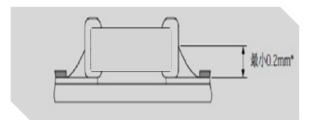
At least 95% of the terminal electrode is covered by new solder. Preheating conditions:80 to 120° C; $10 \sim 30$ s. Solder Temperature: $235 \pm 5^{\circ}$ C Duration: 2 ± 0.5 s, Solder Temperature: $245 \pm 5^{\circ}$ C Duration: 2 ± 0.5 s

Optimum Solder Amount for Reflow Soldering

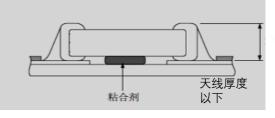


✓ Recommended Soldering Amounts

The optimal solder fillet amounts for re-flow soldering



The optimal solder fillet amounts for wave soldering



Shenzhen Hanyang Antenna Design Co. Ltd. has possession of proprietary information provided in this report and this proprietary information shall be kept in strict confidence and not disclosed to any person or firm without the prior written consent of Shenzhen Hanyang Antenna Design Co. Ltd.

 Shenzhen Baoan District Qianjin 2 Road BaoYunda logistics information building 12A10 tel: 0755-23069700



P/N: HY160808 SRF09

Temperature Cycle Test

 $10\pm1S$ Applied Force: 5N Duration: $10\pm1S$ Preheating conditions: up-category temperature, 1h Recovery time: $24\pm1h$ Initial Measurement Cycling Times: 5 times, 1 cycle, 4 steps:

Stage	Temperature(°C)	Time (minutes)
Step 1	Lower temperature limit (NPOX7R/X75/X65/X5R-55) Y5V:25 Z5U:10	30
Step 2	normal atmospheric temperature(+20)	2-3
Step 3	Upper line temperature $\binom{NPO'X7R/X7S:+125}{Y5V/Z5U/X5R:+85 X6S:+105}$	30
Step 4	normal atmospheric temperature(+20)	2-3

Resistance to Soldering Heat

Preheating 80 to 120° C; $10 \sim 30$ s.SolderTemperature: $235\pm5^{\circ}$ C; Duration: 2 ± 0.5 s; SolderTemperature: $245\pm5^{\circ}$ C Duration: 2 ± 0.5 s; Preheating 100 to 200° C; 10 ± 2 min.

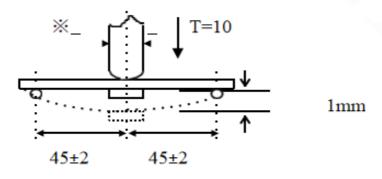
Solder Temperature: 265±5°C; Duration: 10±1s

Clean the capacitor with solvent and examine it with a 10X(min.) microscope.

Recovery Time: 24±2h

Recovery condition: Room temperature

✓ Resistance to Flexure of Substrate



Test Board: Al₂O₃ or PCB Warp: 1mm Speed: 0.5mm/sec. Unit: mm

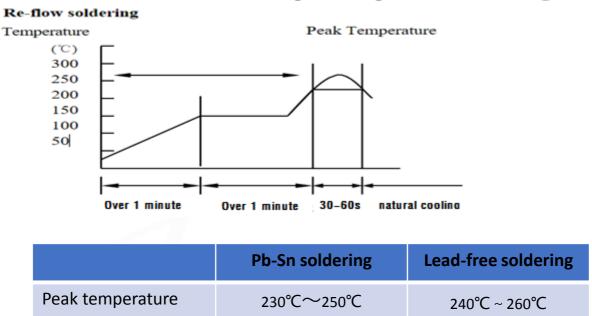
The measurement should be made with the board in the bending position.

Shenzhen Hanyang Antenna Design Co. Ltd. has possession of proprietary information provided in this report and this proprietary information shall be kept in strict confidence and not disclosed to any person or firm without the prior written consent of Shenzhen Hanyang Antenna Design Co. Ltd.

 Shenzhen Baoan District Qianjin 2 Road BaoYunda logistics information building 12A10 tel: 0755-23069700

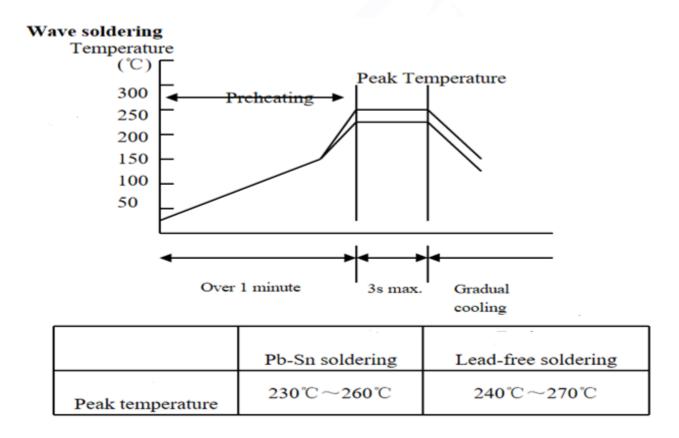
P/N: HY160808 SRF09

 Shenzhen Baoan District Qianjin 2 Road BaoYunda logistics information building 12A10 tel: 0755-23069700



The temperature profile for soldering

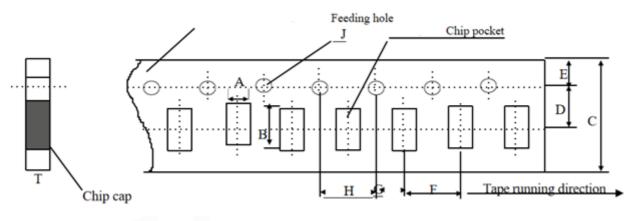
While in preheating, please keep the temperature difference between soldering temperature and surface temperature of chips as: T \leq 150°C.



 Shenzhen Baoan District Qianjin 2 Road BaoYunda logistics information building 12A10 tel: 0755-23069700

P/N: HY160808 SRF09

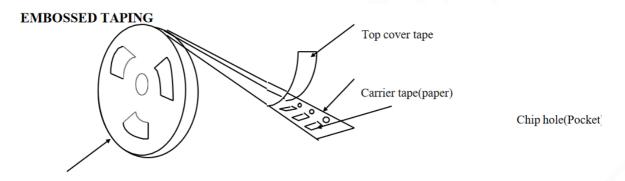
✓ Dimensions of paper taping



Unit: mm

Code	А	В	С	D*	E	F	G*	Н	J	Т
Cino	1.10	1.90	8.00	3.50	1.75	4.00	2.00	4.00	1.50	1.10
Size	±0.10	±0.10	±0.10	±0.05	±0.10	±0.10	±0.10	±0.10	-0/+0.10	Max

Reel (4000 pcs/Reel)



Polystyrene reel

✓ Storage Period

The guaranteed period for solderability is 6 months (Under deliver package condition). Temperature: $5\sim40^{\circ}$ C /Relative Humidity: $20\sim70\%$